

HY1607MF-VB Datasheet N-Channel 60 V (D-S) MOSFET

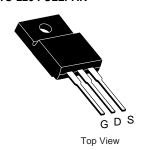
| PRODUCT | SUMMARY | |
|---------------------|-------------------------------------|---------------------------------|
| V _{DS} (V) | $R_{DS(on)}\left(\Omega\right)$ | I _D (A) ^a |
| 60 | 0.005 at V _{GS} = 10 V | 120 |
| 00 | 0.013 at $V_{GS} = 4.5 \text{ V}$ | 95 |

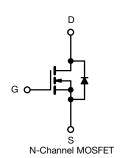
FEATURES

- 175 °C Junction Temperature
- Trench Power MOSFET
- Material categorization:









| ABSOLUTE MAXIMUM RATINGS ($T_C =$ | 25 °C, unless othe | rwise noted) | | |
|---|-------------------------|-----------------------------------|--------------------------------------|------|
| Parameter | | Symbol | Limit | Unit |
| Gate-Source Voltage | | V _{GS} | ± 20 | V |
| One 1 (T. 475.00)b | T _C = 25 °C | - I _D | 120 | |
| Continuous Drain Current (T _J = 175 °C) ^b | T _C = 100 °C | | 95 ^a | |
| Pulsed Drain Current | | I _{DM} | 300 | А |
| Continuous Source Current (Diode Conduction) | | I _S | 70 ^a | |
| Avalanche Current | I _{AS} | 50 | | |
| Single Avalanche Energy (Duty Cycle ≤ 1 %) | L = 0.1 mH | E _{AS} | 125 | mJ |
| Maximum Dayor Dissination | T _C = 25 °C | 136 | | W |
| Maximum Power Dissipation | T _A = 25 °C | P _D | 3 ^b , 8.3 ^{b, c} | |
| Operating Junction and Storage Temperature Range | • | T _J , T _{stg} | - 55 to 175 | °C |

| THERMAL RESISTANCE RATINGS | | | | | | | |
|--|--------------|-------------------|---------|---------|------|--|--|
| Parameter | | Symbol | Typical | Maximum | Unit | | |
| Maximum Junction-to-Ambient ^a | t ≤ 10 sec | R _{thJA} | 15 | 18 | °C/W | | |
| waximum Junction-to-Ambient* | Steady State | | 40 | 50 | | | |
| Maximum Junction-to-Case | | R_{thJC} | 0.85 | 1.1 | | | |

Notes

- a. Package limited.
- b. Surface mounted on 1" x 1" FR4 board.
- c. $t \le 10 \text{ s.}$



| Parameter | Symbol | Test Conditions | Min. | Typ. ^a | Max. | Unit | |
|---|---------------------|---|------|-------------------|-------|------|--|
| Static | | | L | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$ | 60 | | | V | |
| Gate Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_{D} = 250 \mu A$ | 1 | 2 | 3 | V | |
| Gate-Body Leakage | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$ | | | ± 100 | nA | |
| | | $V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$ | | | 1 | | |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} = 60 V, V _{GS} = 0 V, T _J = 125 °C | | | 50 | μΑ | |
| | | V _{DS} = 60 V, V _{GS} = 0 V, T _J = 175 °C | | | 250 | | |
| On-State Drain Current ^b | I _{D(on)} | V _{DS} = 5 V, V _{GS} = 10 V | 60 | | | Α | |
| | | V _{GS} = 10 V, I _D = 20 A | | 0.005 | | | |
| D : 0 | D | V _{GS} = 10 V, I _D = 20 A, T _J = 125 °C | | 0.010 | | 0 | |
| Drain-Source On-State Resistance ^b | R _{DS(on)} | $V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}, T_J = 175 ^{\circ}\text{C}$ | | 0.015 | | Ω | |
| | | $V_{GS} = 4.5 \text{ V}, I_D = 15 \text{ A}$ | | 0.013 | | 1 | |
| Forward Transconductance ^b | 9 _{fs} | $V_{DS} = 15 \text{ V}, I_{D} = 20 \text{ A}$ | | 60 | | S | |
| Dynamic | | | | | | | |
| Input Capacitance | C _{iss} | | | 5650 | | | |
| Output Capacitance | C _{oss} | V _{GS} = 0 V, V _{DS} = 25 V, f = 1 MHz | | 1120 | | pF | |
| Reverse Transfer Capacitance | C _{rss} | | | 525 | | | |
| Total Gate Charge ^c | Qg | | | 47 | 70 | | |
| Gate-Source Charge ^c | Q_{gs} | $V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 50 \text{ A}$ | | 10 | | nC | |
| Gate-Drain Charge ^c | Q _{gd} | | | 12 | | | |
| Turn-On Delay Time ^c | t _{d(on)} | | | 10 | 20 | | |
| Rise Time ^c | t _r | $V_{DD} = 30 \text{ V, } R_L = 0.6 \Omega$ $I_D \cong 50 \text{ A, } V_{GEN} = 10 \text{ V, } R_g = 2.5 \Omega$ | | 15 | 25 | | |
| Turn-Off Delay Time ^c | t _{d(off)} | | | 35 | 50 | ns | |
| Fall Time ^c | t _f | | | 20 | 30 | | |
| Source-Drain Diode Ratings and Cha | aracteristics (| T _C = 25 °C) | | • | | | |
| Pulsed Current | I _{SM} | | | 300 | | Α | |
| Diode Forward Voltage | V_{SD} | I _F = 20 A, V _{GS} = 0 V | | 1 | 1.5 | V | |
| Reverse Recovery Time | t _{rr} | I _F = 20 A, di/dt = 100 A/μs | | 45 | 100 | ns | |

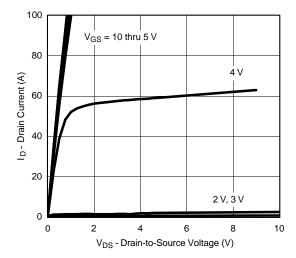
Notes:

- a. For design aid only; not subject to production testing.
- b. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- c. Independent of operating temperature.

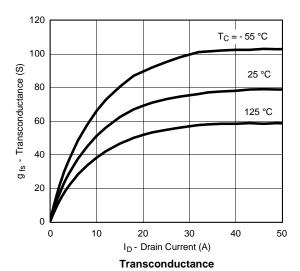
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



TYPICAL CHARACTERISTICS (25 °C unless noted)



Output Characteristics



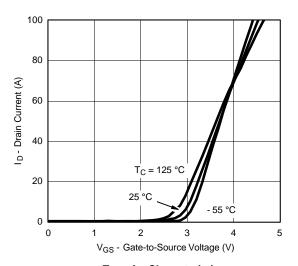
7000 6000 Ciss 5000 Ciss 5000 2000 1000 Coss

 V_{DS} - Drain-to-Source Voltage (V) $\label{eq:capacitance}$

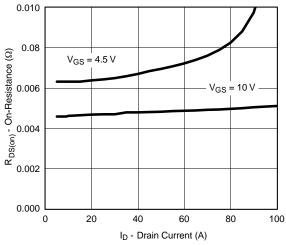
30

50

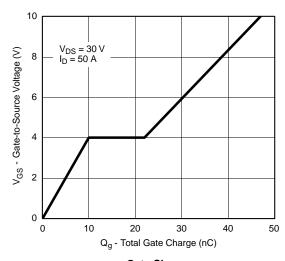
60



Transfer Characteristics



On-Resistance vs. Drain Current



Gate Charge

0 C_{rss}

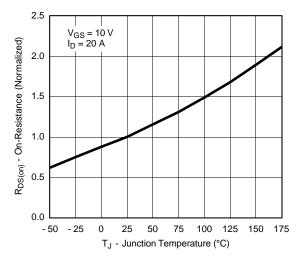
10

0

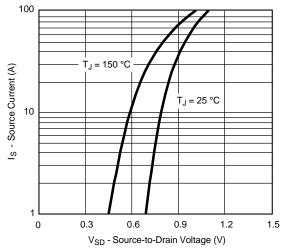
8000



TYPICAL CHARACTERISTICS (25 °C unless noted)



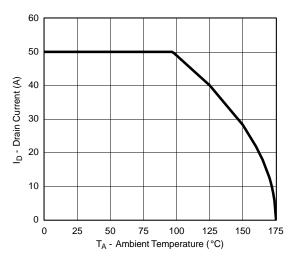
On-Resistance vs. Junction Temperature

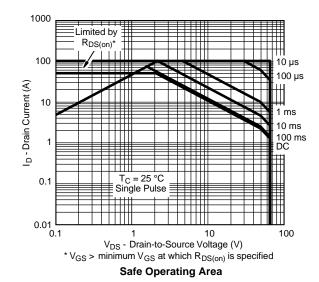


Source-Drain Diode Forward Voltage

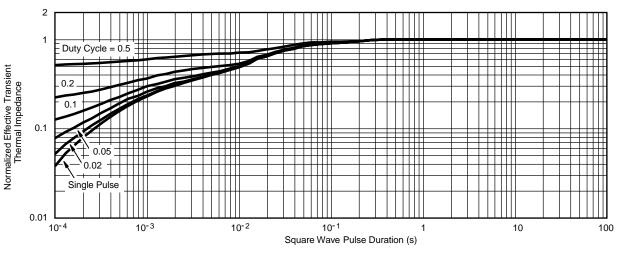


THERMAL RATINGS





Maximum Drain Current vs. Ambient Temperature



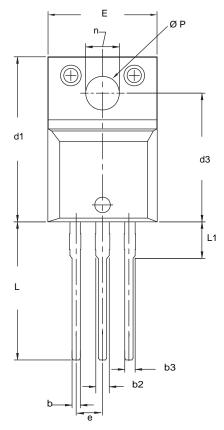
Normalized Thermal Transient Impedance, Junction-to-Case

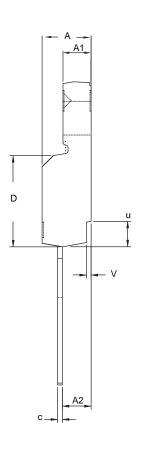
服务热线:400-655-8788

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TO-220 FULLPAK (HIGH VOLTAGE)





| DIM. | MILLIMETERS | | INCHES | |
|------|-------------|--------|--------|-------|
| | MIN. | MAX. | MIN. | MAX. |
| Α | 4.570 | 4.830 | 0.180 | 0.190 |
| A1 | 2.570 | 2.830 | 0.101 | 0.111 |
| A2 | 2.510 | 2.850 | 0.099 | 0.112 |
| b | 0.622 | 0.890 | 0.024 | 0.035 |
| b2 | 1.229 | 1.400 | 0.048 | 0.055 |
| b3 | 1.229 | 1.400 | 0.048 | 0.055 |
| С | 0.440 | 0.629 | 0.017 | 0.025 |
| D | 8.650 | 9.800 | 0.341 | 0.386 |
| d1 | 15.88 | 16.120 | 0.622 | 0.635 |
| d3 | 12.300 | 12.920 | 0.484 | 0.509 |
| E | 10.360 | 10.630 | 0.408 | 0.419 |
| е | 2.54 | BSC | 0.100 | BSC |
| L | 13.200 | 13.730 | 0.520 | 0.541 |
| L1 | 3.100 | 3.500 | 0.122 | 0.138 |
| n | 6.050 | 6.150 | 0.238 | 0.242 |
| ØΡ | 3.050 | 3.450 | 0.120 | 0.136 |
| u | 2.400 | 2.500 | 0.094 | 0.098 |
| V | 0.400 | 0.500 | 0.016 | 0.020 |

ECN: X09-0126-Rev. B, 26-Oct-09 DWG: 5972

- To be used only for process drawing.
 These dimensions apply to all TO-220, FULLPAK leadframe versions 3 leads.
 All critical dimensions should C meet C_{pk} > 1.33.
 All dimensions include burrs and plating thickness.
 No chipping or package damage.



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